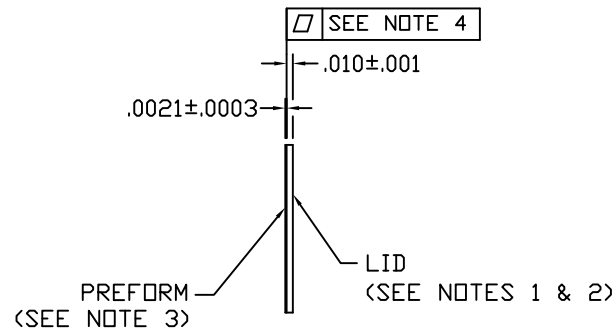
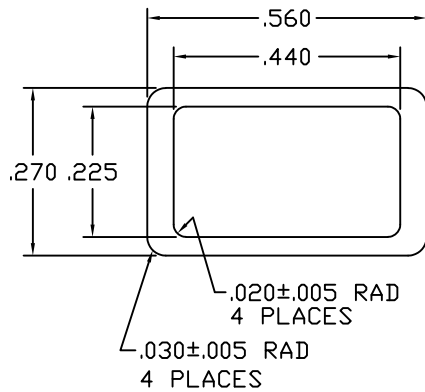


SSM P/N CL562708



NOTES

1. MAT'L : KOVAR OR ALLOY 42
2. PLATING : 1st LAYER 50/350 MICROINCHES Ni
2nd LAYER 25 MICROINCHES MIN Au
3rd LAYER 50/350 MICROINCHES Ni
4th LAYER 25 MICROINCHES MIN Au

NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.

3. PREFORM - 80% ± 1% Au
20% Sn
4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
5. TOLERANCES TO BE (XXX) 3 PLACES ± .003 UNLESS OTHERWISE NOTED

Part Name: CL562708		Description: Hi-Rel Combo Lid	
Part Number: W436H		Mfg: Materion Corporation	Scale 4 = 1
Spectrum Semiconductor Materials Inc. 155 Nicholson Lane San Jose, CA 95134 PH: (408) 435-5555 FX: (408) 435-8226		Approved By: SJO	
		Rev. Date: 10/20/2017	

